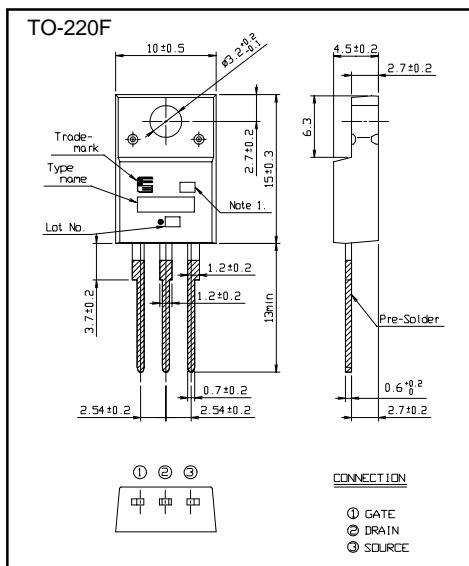


FUJI POWER MOSFET
Super FAP-G Series

N-CHANNEL SILICON POWER MOSFET

■ Outline Drawings



■ Features

- High speed switching
- Low on-resistance
- No secondary breakdown
- Low driving power
- Avalanche-proof

■ Applications

- Switching regulators
- UPS (Uninterruptible Power Supply)
- DC-DC converters

■ Maximum ratings and characteristic

(Tc=25°C unless otherwise specified)

Item	Symbol	Ratings	Unit
Drain-source voltage	VDS	300	V
	VDSX *5	270	V
Continuous drain current	Id	±12	A
Pulsed drain current	Id(puls)	±48	A
Gate-source voltage	VGS	±30	V
Repetitive or non-repetitive	IAR *2	12	A
Maximum Avalanche Energy	EAS *1	193	mJ
Maximum Drain-Source dV/dt	dVDS/dt *4	20	kV/μs
Peak Diode Recovery dV/dt	dV/dt *3	5	kV/μs
Max. power dissipation	Pd	Ta=25°C	2.16
		Tc=25°C	35
Operating and storage temperature range	Tch	+150	°C
	Tstg	-55 to +150	°C
Isolation Voltage	VISO *6	2	kVrms

*1 L=2.32mH, Vcc=48V *2 Tch≤150°C *3 If≤-Id, -di/dt=50A/μs, Vcc≤BVDS, Tch≤150°C

*4 VDS≤300V *5 VGS=-30V *6 t=60sec f=60Hz

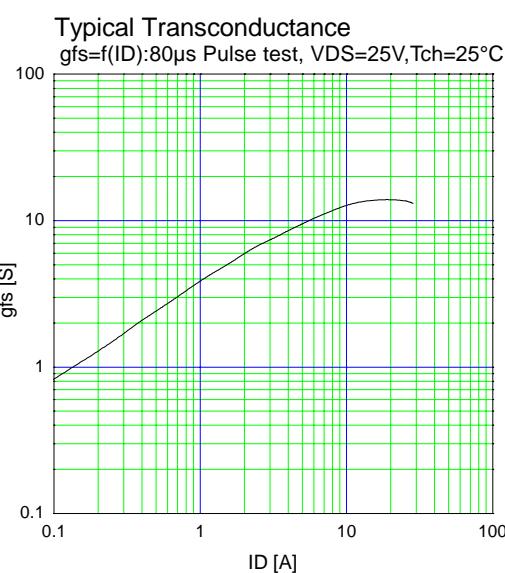
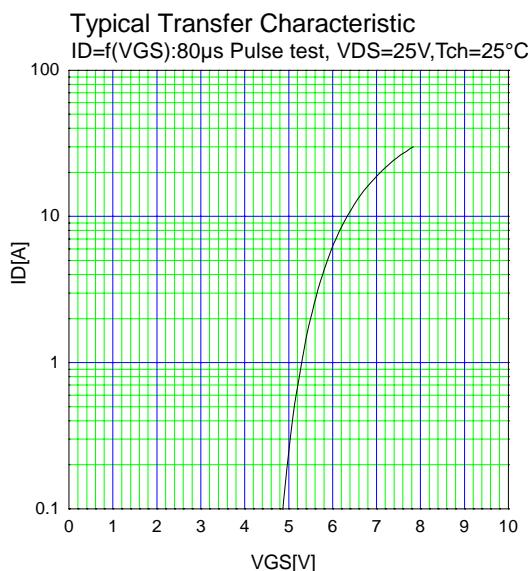
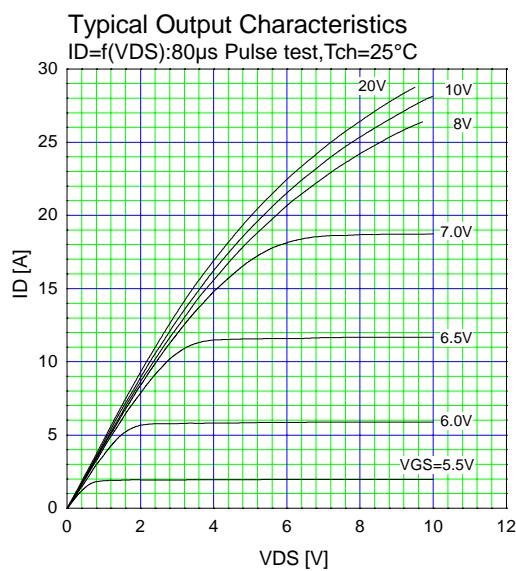
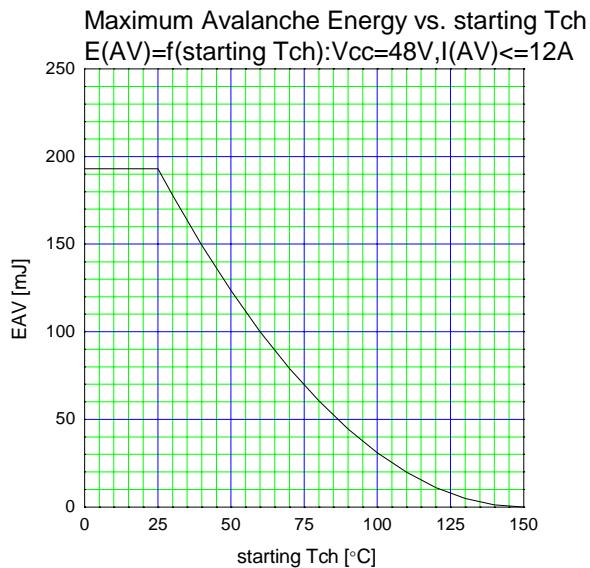
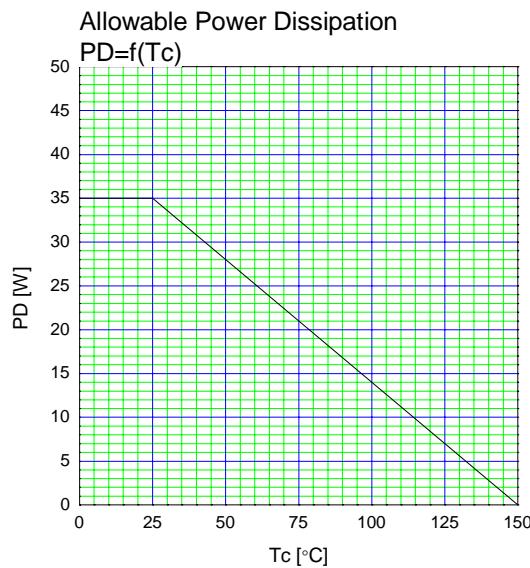
● Electrical characteristics (Tc =25°C unless otherwise specified)

Item	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Drain-source breakdown voltage	V(BR)DSS	Id=250μA VGS=0V	300			V
Gate threshold voltage	VGS(th)	Id= 250μA VDS=VGS	3.5		4.5	V
Zero gate voltage drain current	IdSS	VDS=300V VGS=0V			25	μA
		VDS=240V VGS=0V			250	
Gate-source leakage current	IGSS	VGS=±30V VDS=0V		10	100	nA
Drain-source on-state resistance	RDS(on)	Id=6A VGS=10V		1.22	0.28	Ω
Forward transconductance	gfs	Id=6A VDS=25V	5	10.5		S
Input capacitance	Ciss	VDS=25V VGS=0V f=1MHz	980	1470		pF
Output capacitance	Coss		170	255		
Reverse transfer capacitance	Crss		5.5	11		
Turn-on time ton	td(on)	VCC=150V Id=6A VGS=10V RGS=10Ω		14.5	29	ns
	tr			6.5	9.8	
Turn-off time toff	td(off)			28	42	
	tf			4	6	
Total Gate Charge	QG	VCC=150V Id=12A VGS=10V		23	34.5	nC
Gate-Source Charge	QGS			9.7	14.6	
Gate-Drain Charge	QGD			5.6	11.2	
Avalanche capability	Iav	L=100μH Tch=25°C	12			A
Diode forward on-voltage	VSD	If=12A VGS=0V Tch=25°C		1.20	1.80	V
Reverse recovery time	trr	If=12A VGS=0V -di/dt=100A/μs Tch=25°C		0.2		μs
Reverse recovery charge	Qrr			1.80		

● Thermal characteristics

Item	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Thermal resistance	Rth(ch-c)	channel to case			3.57	°C/W
	Rth(ch-a)	channel to ambient			58.0	°C/W

■ Characteristics



$RDS(on)=f(ID): 80\mu s \text{ Pulse test}, Tch=25^\circ C$

$RDS(on) [\Omega]$

